Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)
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SILICON TRANSISTOR ARRAY



 μ **PA1476**

NPN SILICON POWER TRANSISTOR ARRAY LOW SPEED SWITCHING USE (DARLINGTON TRANSISTOR) INDUSTRIAL USE

DESCRIPTION

The μ PA1476 is NPN silicon epitaxial Darlington Power Transistor Array that built in 4 circuits designed for driving solenoid, relay, lamp and so on.

FEATURES

- Easy mount by 0.1 inch of terminal interval.
- · High hee for Darlington Transistor.
- Surge Absorber (Zener Diode) built in.

ORDERING INFORMATION

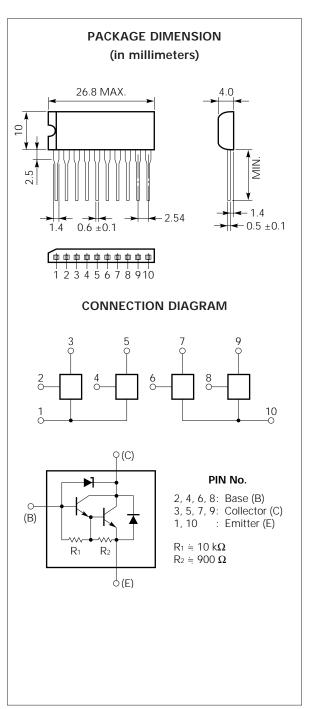
Part Number	Package	Quality Grade
μ PA1476 H	10 Pin SIP	Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Collector to Base Voltage	V_{CBO}	100 ±15	V
Collector to Emitter Voltage	V_{CEO}	100 ±15	V
Emitter to Base Voltage	V_{EBO}	8	V
Collector Current (DC)	Ic(DC)	±2	A/unit
Collector Current (pulse)	Ic(pulse)	* ±3	A/unit
Base Current (DC)	IB(DC)	0.2	A/unit
Total Power Dissipation	P _{T1} **	3.5	W
Total Power Dissipation	P _{T2} ***	28	W
Junction Temperature	TJ	150	°C
Storage Temperature	Tstg -	55 to +150) .C

- * PW \leq 300 μ s, Duty Cycle \leq 10 %
- ** 4 Circuits, Ta = 25 °C
- *** 4 Circuits, Tc = 25 °C



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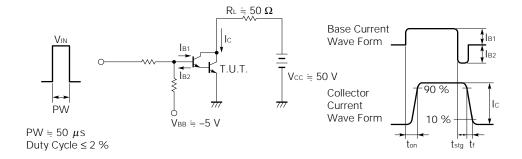


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Leakage Current	Ісво			1.0	μΑ	Vcb = 75 V, IE = 0
Emitter Leakage Current	Івво			1.0	mA	V _{EB} = 5 V, I _C = 0
DC Current Gain	h _{FE1} *	2000		20000	_	Vce = 2 V, Ic = 1 A
DC Current Gain	h _{FE2} *	500			_	Vce = 2 V, Ic = 2 A
Collector Saturation Voltage	VCE(sat) *			1.5	V	Ic = 1 A, I _B = 1 mA
Base Saturation Voltage	V _{BE(sat)} *			2	V	Ic = 1 A, I _B = 1 mA
Turn On Time	ton		1		μs	
Storage Time	tstg		1.2		μs	
Fall Time	tr		0.4		μs	

^{*} PW \leq 350 μ s, Duty Cycle \leq 2 % / pulsed

SWITCHING TIME TEST CIRCUIT

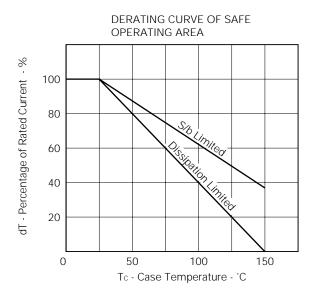


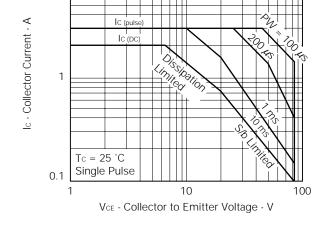
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



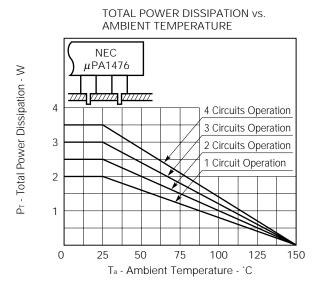
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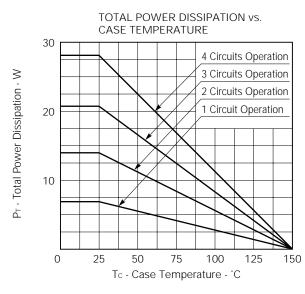
TYPICAL CHARACTERISTICS (TA = 25 °C)

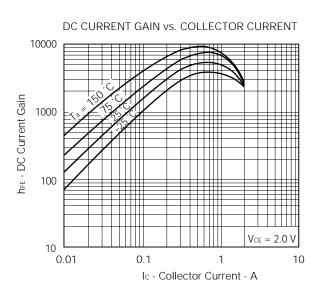


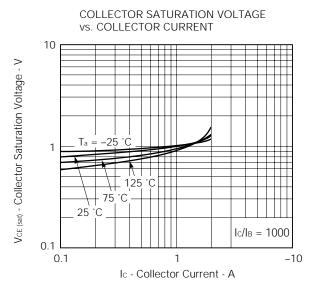


SAFE OPERATING AREA



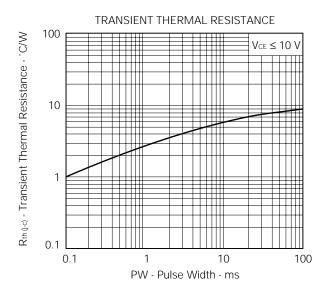


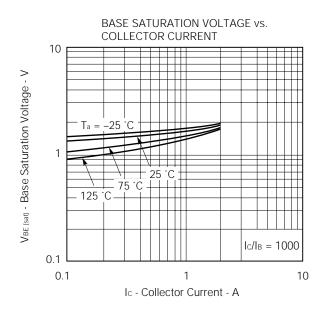


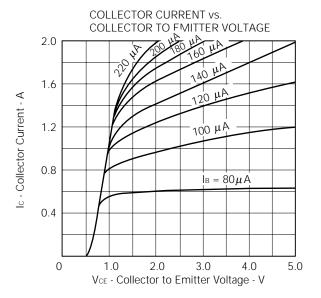


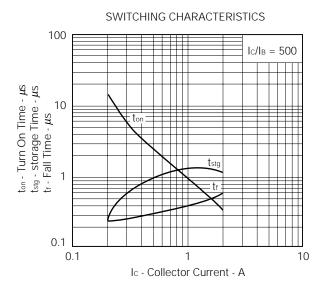
















REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134



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